# SiT9346

1 MHz to 220 MHz Endura<sup>™</sup> Series Ultra-low Jitter Differential Oscillator



### Description

The SiT9346 is a 1 MHz to 220 MHz differential MEMS XO engineered for low-jitter, high reliability applications. Utilizing SiTime's unique DualMEMS<sup>®</sup> temperature sensing and TurboCompensation<sup>®</sup> technology, the SiT9346 delivers exceptional dynamic performance by providing resistance to airflow, thermal gradients, shock and vibration. This device also integrates multiple on-chip regulators to filter power supply noise, eliminating the need for a dedicated external LDO.

The SiT9346 can be factory programmed for any combination of frequency, stability, voltage, and output signaling. Programmability enables designers to optimize clock configurations while eliminating long lead times and customization costs associated with quartz devices where each frequency is custom built.

The wide frequency range and programmability makes this device ideal for aerospace, industrial and defense applications that require a variety of frequencies and operate in noisy environments.

Refer to Manufacturing Notes for proper reflow profile, tape and reel dimension, and other manufacturing related information.

#### Features

- 0.1 ppb/g acceleration sensitivity for harsh environments
- Any frequency between 1 MHz and 220 MHz accurate to 6 decimal places.

For additional frequencies, refer to SiT9347 datasheet

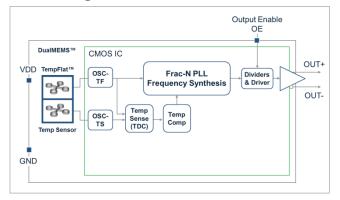
- LVPECL, Low-swing LVPECL, LVDS and HCSL output signaling
- 0.1 ps RMS phase jitter (random) for Ethernet applications
- Frequency stability as low ±10 ppm
- Wide temperature ranges from -40°C to 105°C
- Industry-standard packages: 7.0 x 5.0 mm<sup>2</sup>, 5.0 x 3.2 mm<sup>2</sup>, 3.2 x 2.5 mm<sup>2</sup> packages

### Applications

- Airborne Communications
- Command and Control
- Field Communications
- Airframe/Engine Management Control
- Radar
- SATCOM



#### **Block Diagram**



#### Figure 1. SiT9346 Block Diagram

### Package Pinout

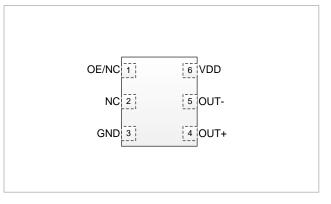
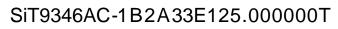
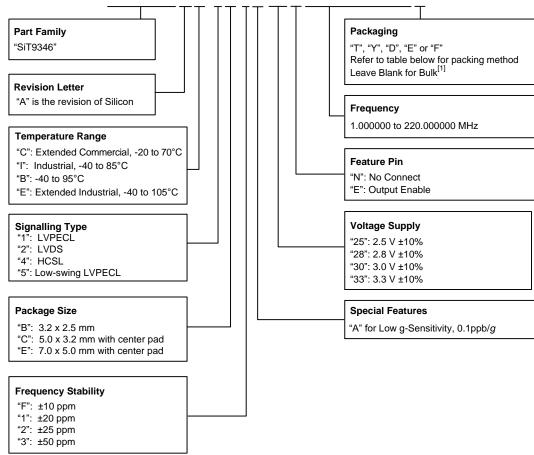


Figure 2. Pin Assignments (Top view) (Refer to Table 6 for Pin Descriptions)



### **Ordering Information**





Notes:

1. Bulk is available for sampling only (up to 24 u).

#### Table 1. Ordering Codes for Supported Tape & Reel Packing Method

| Device Size<br>(mm x mm) | 8 mm T&R<br>(3ku) | 8 mm T&R<br>(1ku) | 12 mm T&R<br>(3ku) | 12 mm T&R<br>(1ku) | 12 mm T&R<br>(<250pcs) | 16 mm T&R<br>(3ku) | 16 mm T&R<br>(1ku) |
|--------------------------|-------------------|-------------------|--------------------|--------------------|------------------------|--------------------|--------------------|
| 7.0 x 5.0                | —                 | —                 | —                  | _                  | —                      | Т                  | Y                  |
| 5.0 x 3.2                | _                 | —                 | Т                  | Y                  | F                      | —                  | —                  |
| 3.2 x 2.5                | D                 | E                 | _                  | _                  | _                      | _                  | _                  |



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| Dimensions and Patterns — 3.2 x 2.5 mm <sup>2</sup> |      |
| Dimensions and Patterns — 5.0 x 3.2 mm <sup>2</sup> |      |
| Dimensions and Patterns — 7.0 x 5.0 mm <sup>2</sup> |      |
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### **Electrical Characteristics**

All Min and Max limits in the Electrical Characteristics tables are specified over temperature and rated operating voltage with standard output termination show in the termination diagrams. Typical values are at 25°C and nominal supply voltage.

# Table 2. Electrical Characteristics – Common to LVPECL, Low-swing LVPECL, LVDS and HCSL (All temperature ranges)

| Parameter                                     | Symbol  | Min. | Тур. | Max.            | Unit     | Condition  |
|---|---------|------|------|-----------------|----------|--|
|   |         |      |      | Frequency Ra    | nge      |  |
| Output Frequency Range                        | f       | 1    | -    | 220.000001      | MHz      | Accurate to 6 decimal places   |
|   |         |      |      | Frequency Stal  | bility   |  |
| Frequency Stability                           | F_stab  | -10  | -    | +10             | ppm      | Inclusive of initial tolerance, operating temperature, rated power   |
|   |         | -20  | -    | +20             | ppm      | supply voltage and load variations   |
|   |         | -25  | -    | +25             | ppm      |  |
|   |         | -50  | -    | +50             | ppm      |  |
| First Year Aging                              | F_1y    | -0.7 | ±0.4 | +0.7            | ppm      | At 85°C  |
| 5 Year Aging                                  | F_5y    | -1.1 | ±0.7 | +1.1            | ppm      | At 85°C  |
| 10 Year Aging                                 | F_10y   | -1.3 | ±0.8 | +1.3            | ppm      | At 85°C  |
| 20 Year Aging                                 | F_20y   | -1.5 | ±1.0 | +1.5            | ppm      | At 85°C  |
|   |         |      |      | Temperature R   | ange     |  |
| Operating Temperature Range                   | T_use   | -20  | -    | +70             | °C       | Extended Commercial  |
|   |         | -40  | -    | +85             | °C       | Industrial   |
|   |         | -40  | -    | +95             | °C       |  |
|   |         | -40  | -    | +105            | °C       | Extended Industrial  |
|   |         |      |      | Rugged Characte | eristics |  |
| Acceleration (g) sensitivity,<br>Gamma Vector | F_g     | -    | -    | 0.1             | ppb/g    | Low sensitivity grade; total gamma over 3 axes; 15 Hz to 2 kHz; MIL-PRF-55310, computed per section 4.8.18.3.1   |
|   |         |      |      | Supply Volta    | ge       |  |
| Supply Voltage                                | Vdd     | 2.97 | 3.30 | 3.63            | V        |  |
|   |         | 2.70 | 3.00 | 3.30            | V        |  |
|   |         | 2.52 | 2.80 | 3.08            | V        |  |
|   |         | 2.25 | 2.50 | 2.75            | V        |  |
|   |         |      |      | Input Character | istics   |  |
| Input Voltage High                            | VIH     | 70%  | -    | -               | Vdd      | Pin 1, OE  |
| Input Voltage Low                             | VIL     | -    | -    | 30%             | Vdd      | Pin 1, OE  |
| Input Pull-up Impedance                       | Z_in    | -    | 100  | -               | kΩ       | Pin 1, OE logic high or logic low  |
|   |         |      |      | Output Characte | ristics  |  |
| Duty Cycle                                    | DC      | 45   | _    | 55              | %        |  |
|   |         |      | ;    | Startup and OE  | Timing   |  |
| Startup Time                                  | T_start | -    | -    | 3.0             | ms       | Measured from the time Vdd reaches its rated minimum value.  |
| OE Enable/Disable Time                        | T_oe    | -    | -    | 3.8             | μs       | f = 156.25 MHz. Measured from the time OE pin reaches rated VIH and VIL to the time clock pins reach 90% of swing and high-Z. See Figure 8 and Figure 9. |



### Table 3. Electrical Characteristics – LVPECL, Low-swing LVPECL

| Parameter                            | Symbol   | Min.    | Typ.           | Max.           | Unit      | Condition   |
|--------------------------------------|----------|---------|----------------|----------------|-----------|---|
|                                      |          |         | Curre          | ent Consump    | otion     | •   |
| Current Consumption                  | ldd      | -       | -              | 89             | mA        | Excluding Load Termination Current, Vdd = 3.3 V or 2.5 V  |
| OE Disable Supply Current            | I_OE     | -       | -              | 58             | mA        | OE = Low  |
| Output Disable Leakage<br>Current    | l_leak   | -       | 0.15           | -              | μΑ        | OE = Low  |
| Maximum Output Current               | I_driver | -       | -              | 32             | mA        | Maximum average current drawn from OUT+ or OUT-   |
| Output Characteristics for LVPECL    |          |         |                |                |           | L   |
| Output High Voltage                  | VOH      | Vdd-1.1 | -              | Vdd-0.7        | V         | See Figure 4  |
| Output Low Voltage                   | VOL      | Vdd-1.9 | -              | Vdd-1.5        | V         | See Figure 4  |
| Output Differential Voltage<br>Swing | V_Swing  | 1.2     | 1.6            | 2.0            | V         | See Figure 5  |
| Rise/Fall Time                       | Tr, Tf   | -       | 225            | 290            | ps        | 20% to 80%, See Figure 5  |
|                                      |          | Outp    |                | istics for Lov | w-swing L | VPECL   |
| Output High Voltage                  | VOH      | Vdd-1.2 | -              | Vdd-0.75       | V         | See Figure 4  |
| Output Low Voltage                   | VOL      | Vdd-1.8 | -              | Vdd-1.25       | V         | See Figure 4  |
| Output Differential Voltage          | V_Swing  | 0.4     | 1              | 1.2            | V         | Output frequency 1 to 220 MHz, See Figure 5   |
| Swing                                |          | 0.4     | 1              | 1.6            | V         | Output frequency greater than 220 MHz, See Figure 5   |
| Rise/Fall Time                       | Tr, Tf   | -       | 225            | 290            | ps        | 20% to 80%. See Figure 5  |
|                                      | -        | -       | Jitter – 7     | .0 x 5.0 mm l  | Package   |   |
| RMS Period Jitter <sup>[2]</sup>     | T_jitt   | -       | 1.0            | 1.6            | ps        | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V  |
| RMS Phase Jitter (random)            | T_phj    | -       | 0.225          | 0.270          | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -20 to 70°C and -40 to 85°C    |
|                                      |          | -       | 0.225          | 0.300          | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -40 to 95°C and -40 to 105°C   |
|                                      |          | -       | 0.1            | -              | ps        | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels. |
|                                      |          | Jitte   | er – 5.0 x 3.2 | and 3.2 x 2.5  | 5 mm Pac  | kages   |
| RMS Period Jitter <sup>[2]</sup>     | T_jitt   | _       | 1.0            | 1.6            | ps        | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V  |
| RMS Phase Jitter (random)            |          | -       | 0.225          | 0.275          | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -20 to 70°C and -40 to 85°C    |
|                                      |          | -       | 0.225          | 0.340          | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -40 to 95°C and -40 to 105°C   |
|                                      |          | -       | 0.1            | -              | ps        | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter mask integration bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd levels.       |

Notes:

2. Measured according to JESD65B.



#### Table 4. Electrical Characteristics – LVDS

| Parameter                         | Symbol | Min.  | Тур.           | Max.         | Unit    | Condition   |
|-----------------------------------|--------|-------|----------------|--------------|---------|---|
|                                   |        |       | Curre          | ent Consum   | ption   |   |
| Current Consumption               | ldd    | -     | -              | 79           | mA      | Excluding Load Termination Current, Vdd = 3.3 V or 2.5 V  |
| OE Disable Supply Current         | I_OE   | I     | -              | 58           | mA      | OE = Low  |
| Output Disable Leakage<br>Current | l_leak | -     | 0.15           | -            | μΑ      | OE = Low  |
|                                   |        |       | Outpu          | ut Character | istics  |   |
| Differential Output Voltage       | VOD    | 300   | -              | 450          | mV      | See Figure 6  |
| Delta VOD                         | ΔVOD   | -     | -              | 50           | mV      | See Figure 6  |
| Offset Voltage                    | VOS    | 1.125 | -              | 1.375        | V       | See Figure 6  |
| Delta VOS                         | ΔVOS   | -     | -              | 50           | mV      | See Figure 6  |
| Rise/Fall Time                    | Tr, Tf | -     | 400            | 470          | ps      | Measured with 2 pF capacitive loading to GND, 20% to 80%, see Figure 7  |
|                                   |        |       | Jitter – 7     | .0 x 5.0 mm  | Package |   |
| RMS Period Jitter <sup>[3]</sup>  | T_jitt | -     | 1.0            | 1.6          | ps      | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V  |
| RMS Phase Jitter (random)         | T_phj  | -     | 0.215          | 0.265        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -20 to 70°C and -40 to 85°C    |
|                                   |        | -     | 0.215          | 0.300        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -40 to 95°C and -40 to 105°C   |
|                                   |        | -     | 0.1            | -            | ps      | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels. |
|                                   |        | Jitte | er – 5.0 x 3.2 | and 3.2 x 2. | 5 mm Pa | ckages  |
| RMS Period Jitter <sup>[3]</sup>  | T_jitt | -     | 1.0            | 1.6          | ps      | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V  |
| RMS Phase Jitter (random)         | T_phj  | -     | 0.235          | 0.275        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -20 to 70°C and -40 to 85°C    |
|                                   |        | -     | 0.235          | 0.320        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -40 to 95°C and -40 to 105°C   |
|                                   |        | -     | 0.1            | -            | ps      | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels. |

Notes: 3. Measured according to JESD65B.



#### Table 5. Electrical Characteristics – HCSL

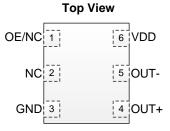
| Parameter                            | Symbol   | Min.  | Тур.           | Max.         | Unit    | Condition   |
|--------------------------------------|----------|-------|----------------|--------------|---------|---|
|                                      |          |       | Curre          | ent Consum   | ption   |   |
| Current Consumption                  | ldd      | -     | -              | 89           | mA      | Excluding Load Termination Current, Vdd = 3.3 V or 2.5 V  |
| OE Disable Supply Current            | I_OE     | -     | -              | 58           | mA      | OE = Low  |
| Output Disable Leakage<br>Current    | I_leak   | -     | 0.15           | -            | μΑ      | OE = Low  |
| Maximum Output Current               | I_driver | I     | _              | 35           | mA      | Maximum average current drawn from OUT+ or OUT-   |
|                                      |          |       | Outpu          | ut Character | istics  |   |
| Output High Voltage                  | VOH      | 0.60  | -              | 0.90         | V       | See Figure 4  |
| Output Low Voltage                   | VOL      | -0.05 | -              | 0.08         | V       | See Figure 4  |
| Output Differential Voltage<br>Swing | V_Swing  | 1.2   | 1.4            | 1.80         | V       | See Figure 5  |
| Rise/Fall Time                       | Tr, Tf   | -     | 360            | 465          | ps      | Measured with 2 pF capacitive loading to GND, 20% to 80%, see Figure 5  |
|                                      |          |       | Jitter – 7     | .0 x 5.0 mm  | Package |   |
| RMS Period Jitter <sup>[3]</sup>     | T_jitt   | -     | 1.0            | 1.6          | ps      | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V  |
| RMS Phase Jitter (random)            | T_phj    | -     | 0.220          | 0.270        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -20 to 70°C and -40 to 85°C  |
|                                      |          | _     | 0.220          | 0.300        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -40 to 95°C and -40 to 105°C |
|                                      |          | -     | 0.1            | -            | ps      | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter mask integration bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd levels.     |
|                                      |          | Jitte | er – 5.0 x 3.2 | and 3.2 x 2. | 5 mm Pa | ckages  |
| RMS Period Jitter <sup>[4]</sup>     | T_jitt   | -     | 1.0            | 1.6          | ps      | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3 V or 2.5 V  |
| RMS Phase Jitter (random)            | T_phj    | -     | 0.230          | 0.275        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -20 to 70°C and -40 to 85°C  |
|                                      |          | -     | 0.230          | 0.340        | ps      | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz,<br>all Vdd levels, includes spurs.<br>Temperature ranges -40 to 95°C and -40 to 105°C |
|                                      |          | -     | 0.1            | -            | ps      | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter mask integration bandwidth = 1.875 MHz to 20 MHz, includes spurs, all Vdd levels.     |

Notes:

4. Measured according to JESD65B.

#### Table 6. Pin Description

| Pin | Мар   |                       | Functionality  |
|-----|-------|-----------------------|--|
| 1   | OE/NC | Output Enable<br>(OE) | H <sup>[5]</sup> : specified frequency output<br>L: output is high impedance |
|     |       | Non Connect<br>(NC)   | H or L or Open: No effect on output frequency or other device functions      |
| 2   | NC    | NA                    | No Connect; Leave it floating or connect to GND for better heat dissipation  |
| 3   | GND   | Power                 | Vdd Power Supply Ground  |
| 4   | OUT+  | Output                | Oscillator output  |
| 5   | OUT-  | Output                | Complementary oscillator output  |
| 6   | Vdd   | Power                 | Power supply voltage <sup>[6]</sup>  |





Notes:

5. In OE mode, a pull-up resistor of 10 k $\Omega$  or less is recommended if pin 1 is not externally driven.

6. A capacitor of value 0.1 µF or higher between VDD and GND is required. An additional 10 µF capacitor between VDD and GND is required for the best phase jitter performance.

#### **Table 7. Absolute Maximum Ratings**

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part.

Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

| Parameter  | Min. | Max.        | Unit |
|--|------|-------------|------|
| Vdd  | -0.5 | 4.0         | V    |
| VIH  |      | Vdd + 0.3 V | V    |
| VIL  | -0.3 |             | V    |
| Storage Temperature  | -65  | 150         | °C   |
| Maximum Junction Temperature   |      | 130         | °C   |
| Soldering Temperature (follow standard Pb-free soldering guidelines) |      | 260         | °C   |

#### Table 8. Thermal Considerations<sup>[7]</sup>

| Package     | $	heta_{	extsf{JA}}$ , 4 Layer Board (°C/W) | $	heta_{	t Jc}$ , Bottom (°C/W) |
|-------------|---|---------------------------------|
| 3225, 6-pin | 80  | 30                              |
| 5032, 6-pin | 53  | 20                              |
| 7050, 6-pin | 52  | 19                              |

Notes:

7. Refer to JESD51 for  $\theta_{JA}$  and  $\theta_{JC}$  definitions, and reference layout used to determine the  $\theta_{JA}$  and  $\theta_{JC}$  values in the above table.

#### Table 9. Maximum Operating Junction Temperature<sup>[8]</sup>

| Max Operating Temperature (ambient) | Maximum Operating Junction Temperature |
|-------------------------------------|--|
| 70°C                                | 95°C                                   |
| 85°C                                | 110°C                                  |
| 95°C                                | 120°C                                  |
| 105°C                               | 130°C                                  |

Notes:

8. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

#### Table 10. Environmental Compliance

| Parameter  | Test Conditions           | Value    | Unit |
|--|---------------------------|----------|------|
| Mechanical Shock Resistance  | MIL-STD-883F, Method 2002 | 10,000   | G    |
| Mechanical Vibration Resistance                                      | MIL-STD-883F, Method 2007 | 70       | G    |
| Soldering Temperature (follow standard Pb free soldering guidelines) | MIL-STD-883F, Method 2003 | 260      | °C   |
| Moisture Sensitivity Level   | MSL1 @ 260°C              |          |      |
| Electrostatic Discharge (HBM)  | HBM, JESD22-A114          | 2,000    | V    |
| Charge-Device Model ESD Protection                                   | JESD220C101               | 750      | V    |
| Latch-up Tolerance   | JESD78 C                  | ompliant |      |



### **Waveform Diagrams**

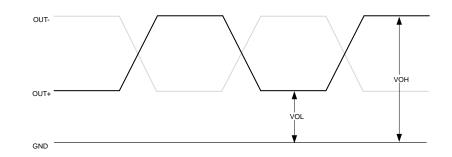


Figure 4. LVPECL, Low-swing LVPECL, and HCSL Voltage Levels per Differential Pin (i.e. OUT+, or OUT-)

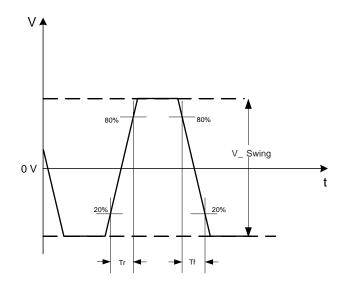
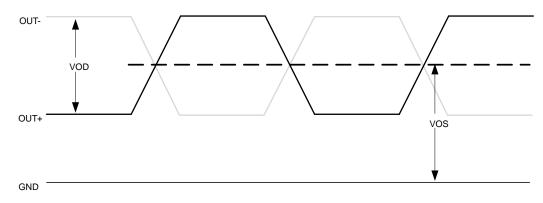
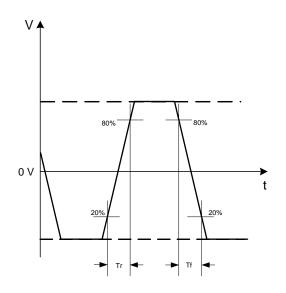


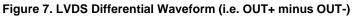
Figure 5. LVPECL, Low-swing LVPECL, and HCSL Voltage Levels Across Differential Pair (i.e. OUT+ minus OUT-)

### Waveform Diagrams (continued)









### **Timing Diagrams**

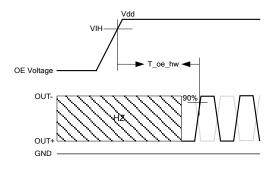


Figure 8. Hardware OE Enable Timing

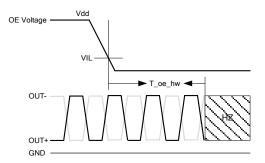
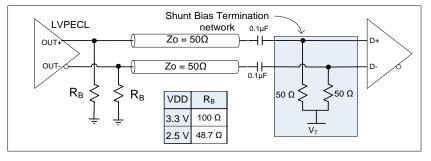


Figure 9. Hardware OE Disable Timing



#### **Termination Diagrams**

#### LVPECL and Low-swing LVPECL





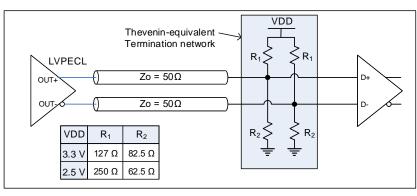


Figure 11. LVPECL and Low-swing LVPECL DC-coupled Load Termination with Thevenin Equivalent Network

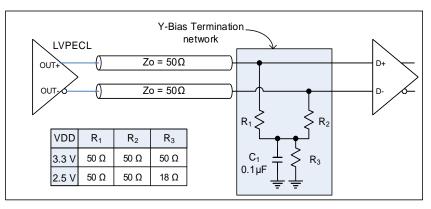
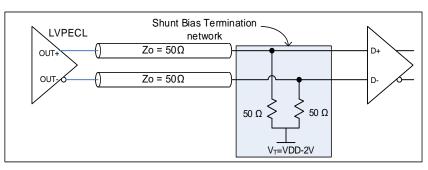


Figure 12. LVPECL and Low-swing LVPECL with Y-Bias Termination







### **Termination Diagrams (continued)**

LVDS

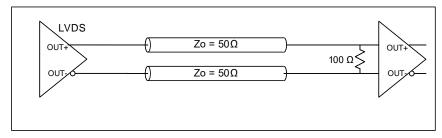
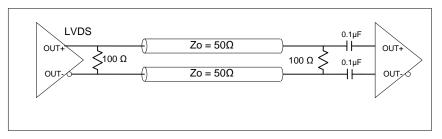
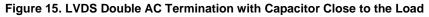


Figure 14. LVDS single DC Termination at the Load





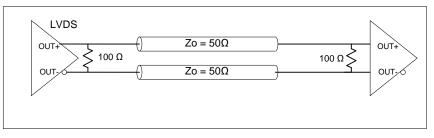


Figure 16. LVDS Double DC Termination

HCSL

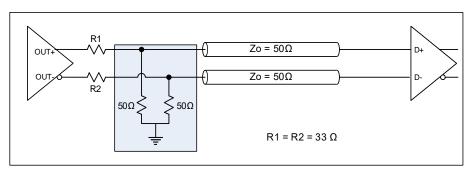
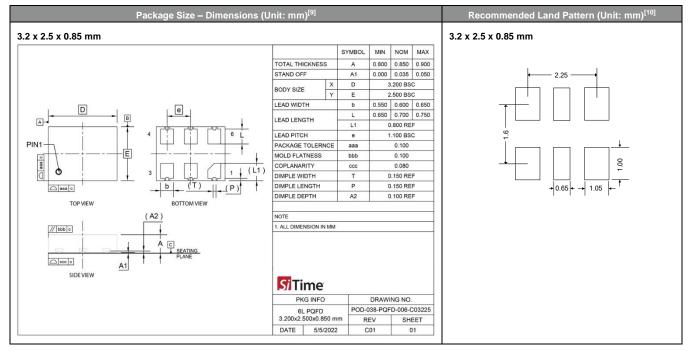


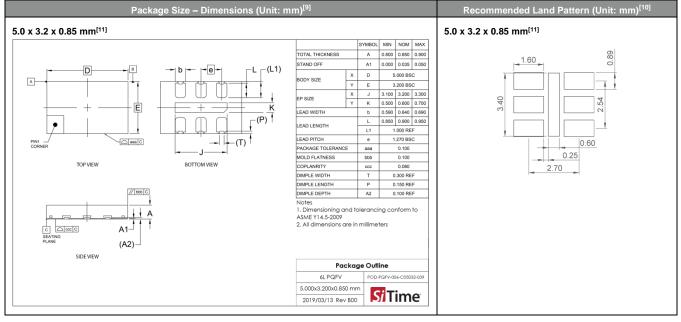
Figure 17. HCSL Interface Termination



### Dimensions and Patterns — 3.2 x 2.5 mm<sup>2</sup>



### Dimensions and Patterns — 5.0 x 3.2 mm<sup>2</sup>

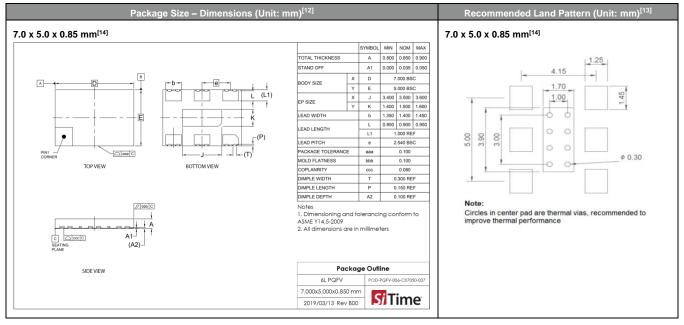


#### Notes:

- 9. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 10. A capacitor of value 0.1 µF or higher between VDD and GND is required. An additional 10 µF capacitor between VDD and GND is required for the best phase jitter performance.
- 11. The center pad has no electrical function. Soldering down the center pad to the GND is recommended for best thermal dissipation, but is optional.



### Dimensions and Patterns — 7.0 x 5.0 mm<sup>2</sup>



Notes:

12. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.

13. A capacitor of value 0.1 μF or higher between VDD and GND is required. An additional 10 μF capacitor between VDD and GND is required for the best phase jitter performance.

14. The center pad has no electrical function. Soldering down the center pad to the GND is recommended for best thermal dissipation, but is optional.



### Additional Information

#### Table 11. Additional Information

| Document                                 | Description  | Download Link  |
|--|--|--|
| ECCN #: EAR99                            | Five character designation used on the<br>commerce Control List (CCL) to identify dual<br>use items for export control purposes.           | _  |
| HTS Classification Code:<br>8542.39.0000 | A Harmonized Tariff Schedule (HTS) code<br>developed by the World Customs Organization<br>to classify/define internationally traded goods. | _  |
| Part number Generator                    | Tool used to create the part number based on<br>desired features.  | www.sitime.com/part-number-generator   |
| Manufacturing Notes                      | Tape & Reel dimension, reflow profile and<br>other manufacturing related info  | www.sitime.com/sites/default/files/gated/Manufacturing-Notes-for-SiTime-<br>Products.pdf |
| Qualification Reports                    | RoHS report, reliability reports,<br>composition reports   | www.sitime.com/support/quality-and-reliability   |
| Performance Reports                      | Additional performance data such as phase<br>noise, current consumption and jitter for<br>selected frequencies                             | www.sitime.com/support/performance-measurement-report                                    |
| Termination Techniques                   | Termination design recommendations   | www.sitime.com/support/application-notes   |
| Layout Techniques                        | Layout recommendations   | www.sitime.com/support/application-notes   |
| Evaluation Boards                        | SiT6085/6EB rev. 3.0, SiT6085EB rev.3.1 and<br>SiT6097EB rev. 2.0 Evaluation Boards for<br>Differential Oscillators User Manual            | www.sitime.com/support/user-guides   |



### **Revision History**

#### **Table 12. Revision History**

| Revision | Release Date | Change Summary   |
|----------|--------------|--|
| 0.5      | 22-Jul-2019  | Initial draft  |
| 1.00     | 24-Jul-2020  | Updated package Dimensions Drawings<br>Updated Table 8 Thermal Considerations for 5032 package<br>Updated Table 2 specification for First Year Aging<br>Added 5, 10, and 20 year aging specs<br>Added Evaluation Boards SiT6085EB reference in Additional Information<br>Rearranged layout, added Description, Block Diagram and TOC<br>Tightened LVDS minimum VOD specification<br>Added HTS code<br>Added low-swing LVPECL package code and specifications |
| 1.01     | 9-May-2022   | Updated L1 and Dimple Width package dimensions for 3.2 x 2.5 mm package<br>Updated trademarks, hyperlinks and changed rev table date format<br>Fixed pin numbering for 3.2 x 2.5 mm package dimensions drawing   |
| 1.02     | 21-Nov-2022  | Updated Ordering packaging information with F option<br>Updated hyperlinks and icons on page 1. Disclaimer update  |

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